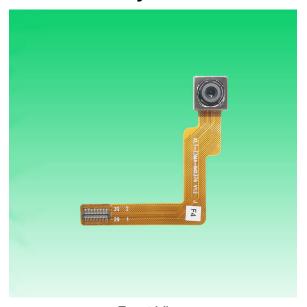
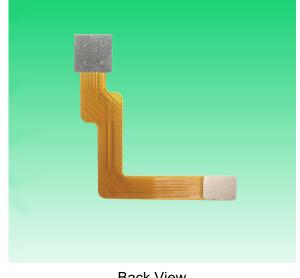




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KLT-Z3MA-IMX376 V1.2 20MP Sony IMX376 MIPI Interface Auto Focus Camera Module





Front View

Back View

Specifications

Camera Module No.	KLT-Z3MA-IMX376 V1.2	
Resolution	20 MP	
Image Sensor	IMX376	
Sensor Type	1/2.78"	
Pixel Size	1.00 um x 1.00 um	
EFL	3.95 mm	
F.NO	1.8	
Pixel	5216 x 3896	
View Angle	78.0°(DFOV) 65.9°(HFOV) 52.0°(VFOV)	
Lens Dimensions	8.80 x 8.80 x 5.65 mm	
Module Size	39.28 x 38.90 mm	
Module Type	Auto Focus	
Interface	MIPI	
Auto Focus VCM Driver IC	DW9763	
Lens Type	650nm IR Cut	
Operating Temperature	-20°C to +60°C	
Mating Connector	BBR43-30KB533	





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KLT-Z3MA-IMX376 V1.2 20MP Sony IMX376 MIPI Interface Auto Focus Camera Module



Top View



Side View



Bottom View



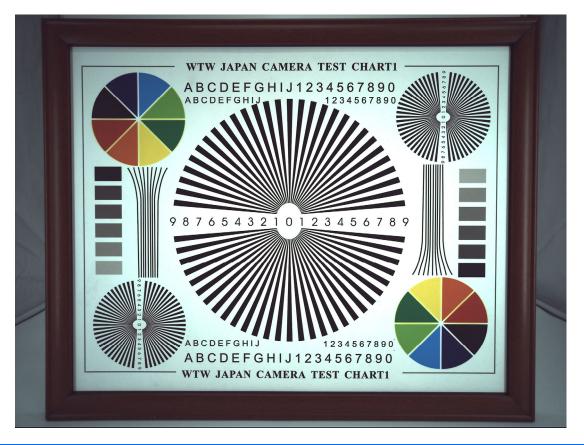
Mating Connector





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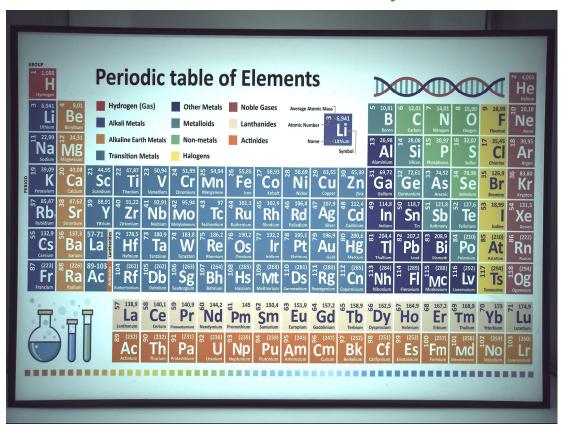




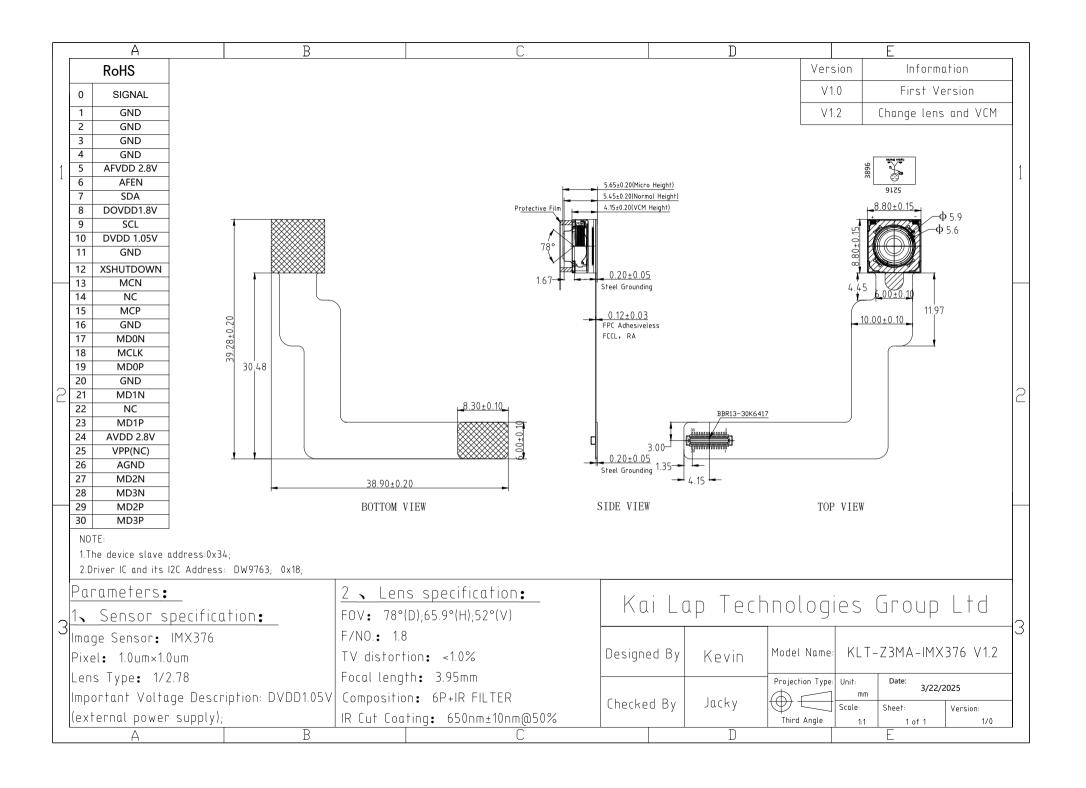




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SONY

Diagonal 6.475 mm (Type 1/2.78) 20Mega-Pixel CMOS Image Sensor with Square Pixel for Color Cameras

IMX376-AAJH5-C

General description and application

IMX376 is a diagonal 6.475 mm (Type 1/2.78) 20 Mega-pixel CMOS active pixel type stacked image sensor with a square pixel array. It adopts Exmor RS[™] technology to achieve high speed image capturing by column parallel A/D converter circuits and high sensitivity and low noise image (comparing with conventional CMOS image sensor) through the backside illuminated imaging pixel structure. R, G, and B pigment primary color mosaic filter is employed. It operates with four power supply: analog 2.8 V, 1.8V, digital 1.05 V and 1.8 V for input/output interface and achieves low power consumption. It is optionally operational with conventional three power supplies by using an analog power supply voltage of 2.8V.

In addition, this product is designed for use in cellular phone and tablet pc. When using this for another application, Sony Semiconductor Solutions Corporation does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and tablet pc. Consult your Sony Semiconductor Solutions Corporation sales representative if you have any questions.

Functions and Features

- ◆ Back-illuminated and stacked CMOS image sensor Exmor RS
- ♦ High Frame Rate 30fps@Full resolution / 120fps@2x2 Adjacent Pixel Binning (4:3) / 150fps@2x2 Adjacent Pixel Binning (16:9)
- ◆ Electronic Image Stabilization (EIS)
- ◆ High signal to noise ratio(SNR)
- ◆ Dual sensor synchronization operation
- ◆ Built-in 2D Dynamic Defect Pixel Correction
- ◆ Lens Shading Correction (LSC)
- ◆ Built-in temperature sensor
- ◆ Output video format of RAW10/8, COMP8
- ◆ Pixel binning readout function
- ◆ Two PLLs for independent clock generation for pixel control and data output interface
- CSI-2 serial data output (MIPI 2lane/4lane, Max. 2.3Gbps/lane, D-PHY spec. ver. 1.2 compliant)
- ◆2-wire serial communication
- ◆ Advanced Noise Reduction (Chroma noise reduction and RAW noise reduction)
- ♦ 12K bit of OTP ROM for users
- Quad Bayer Coding color filter arrangement



Sony Semiconductor Solutions Corporation reserves the right to change products and specifications without prior notice. This information does not convey any license by any implication or otherwise under any patents or other right. Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony Semiconductor Solutions Corporation cannot assume responsibility for any problems arising out of the use of these circuits.

Device Structure

◆ CMOS image sensor

♦ Image size : Diagonal 6.475 mm (Type 1/2.78)

◆ Total number of pixels : 5216 (H) × 4032 (V) approx. 21.03 M pixels ◆ Number of effective pixels : 5216 (H) × 3896 (V) approx. 20.32 M pixels ◆ Number of active pixels : 5184 (H) × 3880 (V) approx. 20.11 M pixels

♦ Chip size : 6.415 mm (H) × 4.759 mm (V) ♦ Unit cell size : 1.00 μm (H) × 1.00 μm (V)

◆ Substrate material : Silicon

Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	notes	
Supply voltage (analog)	VANA1	-0.3 to +4.2	V		
Supply voltage (digital)	VDIG	-0.3 to +1.54	V		
Supply voltage (interface)	VIF	-0.3 to +2.52	V	refer to	
Input voltage (digital)	VI	-0.3 to +2.52	V	VSS level	
Output voltage (digital)	VO	-0.3 to +2.52	V		
Supply voltage (analog)	VANA2	-0.3 to +4.2	V		
Guaranteed Operating temperature	TOPR	-20 to +70	°C		
Guaranteed storage temperature	TSTG	-30 to +80	°C		
Guaranteed performance temperature	TSPEC	-20 to +60	°C		

Recommended Operating Voltage

Item	Symbol	Ratings	Unit	notes
Supply voltage (analog)	VANA1	2.8 ± 0.1	V	
Supply voltage (digital)	VDIG	1.05 ± 0.1	V	
Supply voltage (interface)	VIF	1.8 ± 0.1	V	refer to
		2.8±0.1		VSS level
Supply voltage (analog)	VANA2(*)	or	V	
		1.8±0.1		

Note: 1.8V is recommended. For details, refer to DC characteristics.



1. General Description

The DW9763 is a single 10-bit DAC with 100mA output current sinking capability and embedded 8KByte eFlash memory. Designed for linear control of voice coil motors, the DW9763 is capable of operating voltage up to 3.3V.

The SAC (Smart Actuator Control) mode is applied to minimize the mechanical vibration. The SAC mode highly improves the actuator's settling time and tolerance coverage compared with conventional LSC (Linear Slope Control) mode. The DAC and eFlash are controlled via an I2C compatible serial interface.

The DW9763 incorporates with a POR (Power On Reset) circuit, power down mode. POR circuit gets to operate when VDD (supply power) turns on. The output current keeps 0mA until valid register value takes place. During the power down mode, it consumes current max.1uA.

The DW9763 is designed for auto focus and optical zoom for mobile camera, digital still camera, camcorders and other nano actuator applications.

■ Features

10 bit resolution current sinking of 100mA for VCM

SAC (Smart Actuator Control) mode

Supply voltage range (VDD): 2.3V to 3.3V

Fast mode I2C interface compatible (1.8V interface available)

Power down mode

Power on reset (POR)

Embedded 8KByte eFlash memory

Package: 8 pin WLCSP

Package Size: 0.77mm X 1.75mm X 0.3mm

■ Applications

Mobile camera
Digital still camera
Camcorder
Web camera

Nano actuator

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Cameras Applications



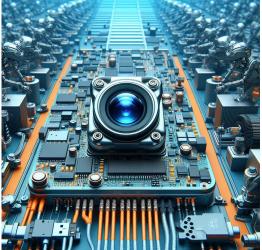


Automotive Driver Pilot

Live Streaming

Video Conference







Eye Tracker Biometric Detection

Machine Vision

Agricultural Monitor







Night Vision Security

Drone and Sports Eagle Eyes

Interactive Pet Camera





Cameras Applications

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Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Ap	tina Himax GalaxyCore PixArt SmartSens Sensors		
Pin Signal	Description		
DGND GND	ground for digital circuit		
AGND	ground for analog circuit		
PCLK DCK	DVP PCLK output		
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resiste		
MCLK XVCLK XCLK INCK	system input clock		
RESET RST	reset active low with internal pull-up resistor		
NC NULL	no connect		
SDA SIO_D SIOD	SCCB data		
SCL SIO C SIOC	SCCB input clock		
VSYNC XVS FSYNC	DVP VSYNC output		
HREF XHS	DVP HREF output		
DOVDD	power for I/O circuit		
AFVDD	power for VCM circuit		
AVDD	power for analog circuit		
DVDD	power for digital circuit		
STROBE FSTROBE	strobe output		
FSIN	synchronize the VSYNC signal from the other sensor		
SID	SCCB last bit ID input		
ILPWM	mechanical shutter output indicator		
FREX	frame exposure / mechanical shutter		
GPIO	general purpose inputs		
SLASEL	I2C slave address select		
AFEN	CEN chip enable active high on VCM driver IC		
MIPI Interface			
MDN0 DN0 MD0N DATA N DMO1N	MIPI 1st data lane negative output		
MDP0 DP0 MD0P DATA P DMO1P	MIPI 1st data lane positive output		
MDN1 DN1 MD1N DATA2 N DMO2N	MIPI 2nd data lane negative output		
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output		
MDN2 DN2 MD2N DATA3 N DMO3N	MIPI 3rd data lane negative output		
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output		
MDN3 DN3 MD3N DATA4 N DMO4N	MIPI 4th data lane negative output		
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output		
MCN CLKN CLK_N DCKN	MIPI clock negative output		
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output		
DVP Parallel Interface			
D0 DO0 Y0	DVP data output port 0		
D1 DO1 Y1	DVP data output port 1		
D2 DO2 Y2	DVP data output port 2		
D3 DO3 Y3	DVP data output port 3		
D4 DO4 Y4	DVP data output port 4		
D5 DO5 Y5	DVP data output port 5		
D6 DO6 Y6	DVP data output port 6		
D7 DO7 Y7	DVP data output port 7		
D8 DO8 Y8	DVP data output port 8		
D9 DO9 Y9	DVP data output port 9		
D10 DO10 Y10	DVP data output port 10		
D11 D011 Y11	DVP data output port 11		





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Camera Reliability Test

Reliability Inspection Item		Tooting Motherd	A cooptones Critoria		
Category		Item	Testing Method	Acceptance Criteria	
	Storage	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Temperature	Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Operation	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation	
For decomposite t	Temperature	Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation	
	Thermal Shock High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours		Temperature Chamber	No Abnormal Situation	
	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional	
		With Package 60cm	10 Times on Wood Floor	Electrically Functional	
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional	
Physical		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional	
Pilysical		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional	
	Cable Tensile Strength Test Loading Weight 4 kg 60 Seconds Cycling in 24 Hours		Tensile Testing Machine	Electrically Functional	
Electrical	FOD Total	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional	
	ESD Test	Air Discharge 4 KV	ESD Testing Machine	Electrically Functional	
	Aging Test On/Off 30 Seconds Cycling in 24 Hours		Power Switch	Electrically Functional	
USB Connector		On/Off 250 Times	Plug and Unplug	Electrically Functional	













Camera Inspection Standard

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Inspection Item		n Item	Lanca Cara Madha d	Standard of Inspection	
Category		Item	Inspection Method		
FF		Color	The Naked Eye	Major Difference is Not Allowed.	
	FPC/ PCB	Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
		Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Gap	The Naked Eye	Meet the Height Standard	
Appearance	Holder	Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Scratch	The Naked Eye	No Effect On Resolution Standard	
	Long	Contamination	The Naked Eye	No Effect On Resolution Standard	
	Lens	Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
		No Communication	Test Board	Not Allowed	
	Image	Bright Pixel	Black Board	Not Allowed In the Image Center	
		Dark Pixel	White board	Not Allowed In the Image Center	
		Blurry	The Naked Eye	Not Allowed	
		No Image	The Naked Eye	Not Allowed	
		Vertical Line	The Naked Eye	Not Allowed	
		Horizontal Line	The Naked Eye	Not Allowed	
Function		Light Leakage	The Naked Eye	Not Allowed	
		Blinking Image	The Naked Eye	Not Allowed	
		Bruise	Inspection Jig	Not Allowed	
		Resolution	Chart	Follows Outgoing Inspection Chart Standard	
		Color	The Naked Eye	No Issue	
		Noise	The Naked Eye	Not Allowed	
		Corner Dark	The Naked Eye	Less Than 100px By 100px	
		Color Resolution	The Naked Eye	No Issue	
		Height	The Naked Eye	Follows Approval Data Sheet	
Dimor	neion	Width	The Naked Eye	Follows Approval Data Sheet	
Dillel	Dimension Length The Naked Ey		The Naked Eye	Follows Approval Data Sheet	
	Overall		The Naked Eye	Follows Approval Data Sheet	

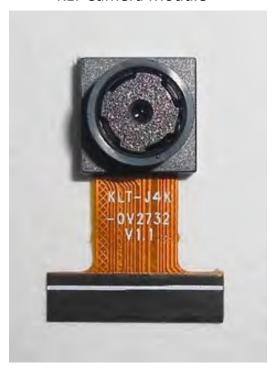




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KLT Package Solutions

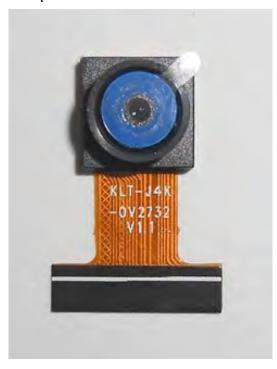
KLT Camera Module



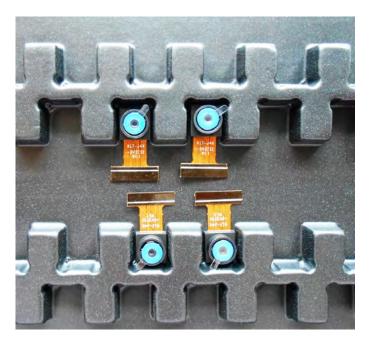
Tray with Grid and Space



Complete with Lens Protection Film



Place Cameras on the Tray







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Camera Modules Package Solution

Full Tray of Cameras



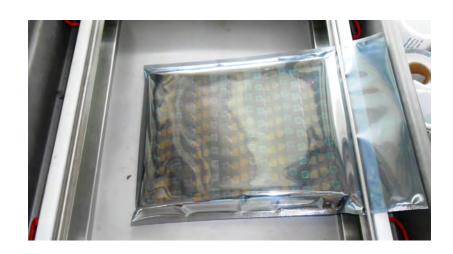
Put Tray into Anti-Static Bag



Cover Tray with Lid



Vacuum the Anti-Static Bag







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Camera Modules Package Solution

Sealed Vacuum Bag with Labels 1. Model and Description 2. Quantity 3. Shipping Date 4. Caution







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Large Order Package Solution

Place Foam Sheets Between Trays

Foam Sheets are Slightly Larger than Trays





Place Foam Sheets and Trays into Box

Foam Sheets are Tightly Fitting Box





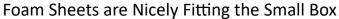




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Small Order Package Solution

Place Foam Sheets and Trays into Small Box







Package in Small Box for Shipment

Place Small Boxes into Larger Box









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Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box





Carbon Box Ready for Shipment 1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution







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Sample Order Package Solution

Place Sample into Small Anti-Static Bag



Place Connectors into Small Ant-Static Bag





Sample Labels on the Small Bag 1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution



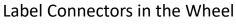




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Connectors Large Order Package Solution

Connectors in a Wheel







The Wheel is Perfectly Fitting the Box

Connectors Box Ready for Shipment









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Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.





Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, www.KaiLapTech.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequential events.

















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KLT Strength

Powerful Factory





Professional Service







Promised Delivery











